<table>
<thead>
<tr>
<th>Item</th>
<th>Qty</th>
<th>Reference</th>
<th>Value</th>
<th>Part Description</th>
<th>Manufacturer</th>
<th>Manufacturer Part Number</th>
<th>Alternate Part</th>
<th>PCB Footprint</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1</td>
<td>J1</td>
<td></td>
<td>Header, 50mil, 10x1, Tin, Through Hole</td>
<td>Preci-Dip</td>
<td>850-80-010-10-001101</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
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